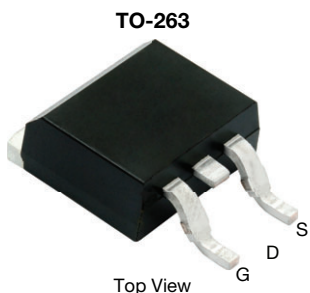


P-Channel 80 V (D-S) MOSFET



FEATURES

- TrenchFET® power MOSFET
- Package with low thermal resistance
- Maximum 175 °C junction temperature
- Low $R_{DS(on)}$ minimizes power loss from conduction
- Compatible with logic-level gate driving
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

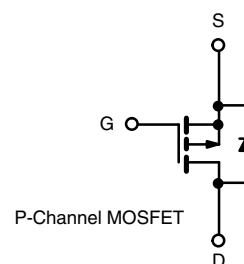


RoHS
COMPLIANT
HALOGEN
FREE

PRODUCT SUMMARY	
V_{DS} (V)	-80
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -10$ V	0.0061
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -4.5$ V	0.0086
Q_g typ. (nC)	145
I_D (A)	-150
Configuration	Single

APPLICATIONS

- Battery protection
- Motor drive control
- Load switch



ORDERING INFORMATION	
Package	TO-263
Lead (Pb)-free and halogen-free	SUM60061EL-GE3

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V _{DS}	-80	V
Gate-source voltage		V _{GS}	± 20	
Continuous drain current ^d (T _J = 175 °C)	T _C = 25 °C	I _D	-150 ^d	A
	T _C = 70 °C		-150 ^d	
Pulsed drain current (100 μs)		I _{DM}	-250	
Avalanche current	L = 0.1 mH	I _{AS}	-75	
Single pulse avalanche energy ^a		E _{AS}	281	mJ
Power dissipation	T _C = 25 °C ^c	P _D	375	W
	T _C = 125 °C ^b		125	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB mount ^b	R_{thJA}	40	°C/W
Junction-to-case		R_{thJC}	0.4	

Notes

- Duty cycle ≤ 1 %
- When mounted on 1" square PCB (FR4 material)
- See SOA curve for voltage derating
- Limited by package



SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = -10 mA	-80	-	-	V
Gate threshold voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250 μA	-1.5	-	-2.5	
Gate-body leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 20 V	-	-	± 100	nA
Zero gate voltage drain current	I _{DSS}	V _{DS} = -80 V, V _{GS} = 0 V	-	-	-10	μA
		V _{DS} = -64 V, V _{GS} = 0 V, T _J = 125 °C	-	-	-50	
		V _{DS} = -64 V, V _{GS} = 0 V, T _J = 175 °C	-	-	-250	
On-state drain current ^a	I _{D(on)}	V _{DS} ≤ -5 V, V _{GS} = -10 V	-30	-	-	A
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = -10 V, I _D = -20 A	-	0.0051	0.0061	Ω
		V _{GS} = -4.5 V, I _D = -15 A	-	0.0069	0.0086	
Forward transconductance ^a	g _{fs}	V _{DS} = -15 V, I _D = -15 A	-	80	-	S
Dynamic ^b						
Input capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = -40 V, f = 1 MHz	-	9600	-	pF
Output capacitance	C _{oss}		-	3300	-	
Reverse transfer capacitance	C _{rss}		-	110	-	
Total gate charge ^c	Q _g	V _{DS} = -40 V, V _{GS} = -10 V, I _D = -110 A	-	145	218	nC
Gate-source charge ^c	Q _{gs}		-	34	-	
Gate-drain charge ^c	Q _{gd}		-	16	-	
Gate resistance	R _g	f = 1 MHz	0.46	2.3	4.6	Ω
Turn-on delay time ^c	t _{d(on)}	V _{DD} = -40 V, R _L = 0.71 Ω I _D ≅ -20 A, V _{GEN} = -10 V, R _g = 1 Ω	-	25	35	ns
Rise time ^c	t _r		-	20	30	
Turn-off delay time ^c	t _{d(off)}		-	90	140	
Fall time ^c	t _f		-	20	30	
Drain-Source Body Diode Characteristics (T _C = 25 °C ^b)						
Continuous current	I _S		-	-	-150	A
Pulsed current	I _{SM}		-	-	-250	
Forward voltage ^a	V _{SD}	I _F = -10 A, V _{GS} = 0 V	-	-0.8	-1.5	V
Reverse recovery time	t _{rr}	I _F = -20 A, dI/dt = 100 A/μs	-	90	135	ns
Peak reverse recovery charge	I _{RM(REC)}		-	-2.8	-4.2	A
Reverse recovery charge	Q _{rr}		-	145	218	nC

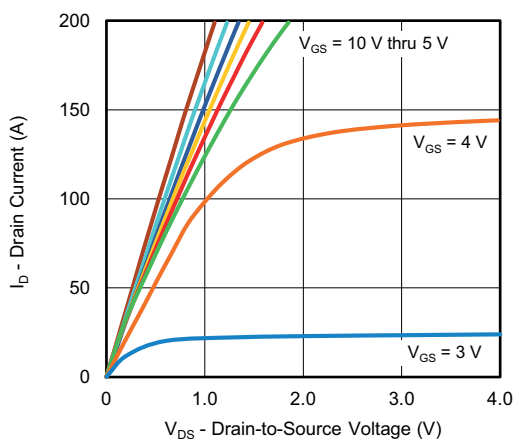
Notes

- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$
b. Guaranteed by design, not subject to production testing
c. Independent of operating temperature

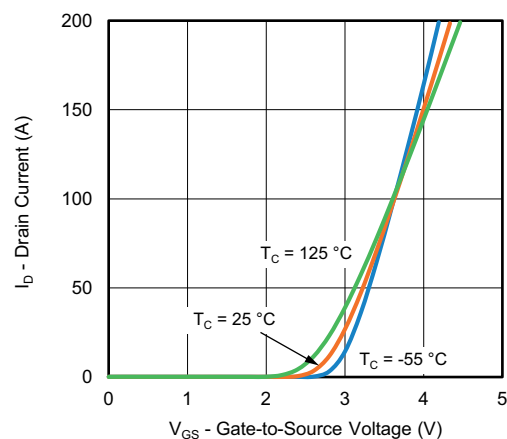
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



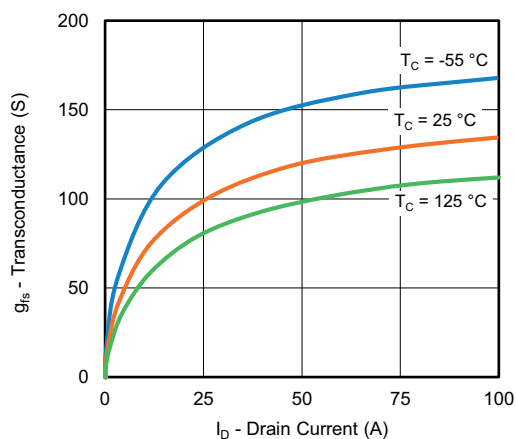
TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)



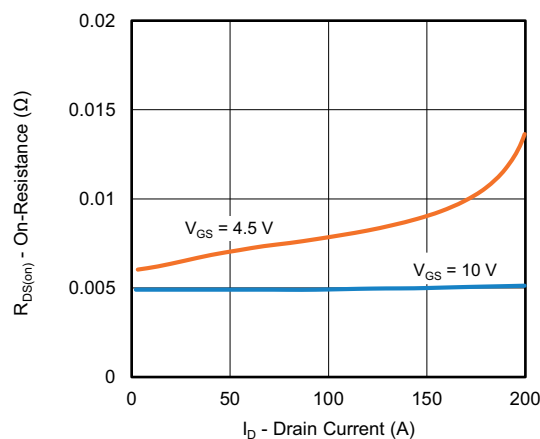
Output Characteristics



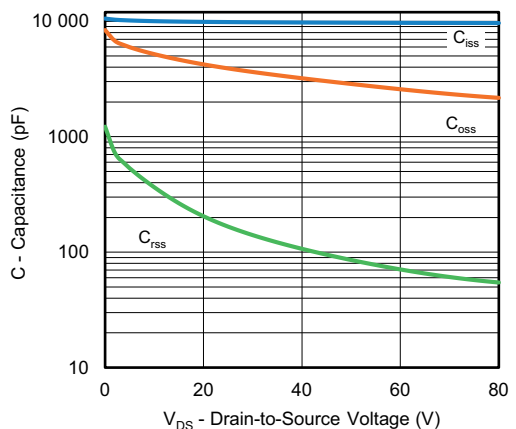
Transfer Characteristics



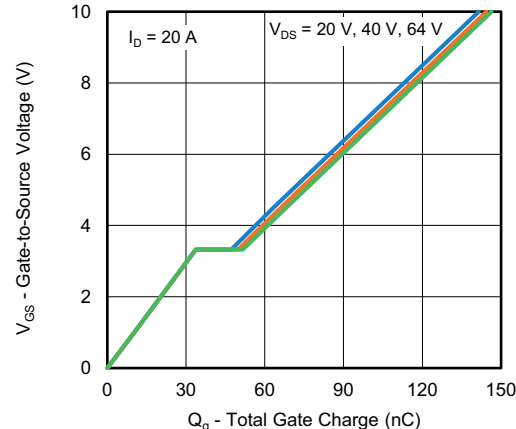
Transconductance



On-Resistance vs. Drain Current



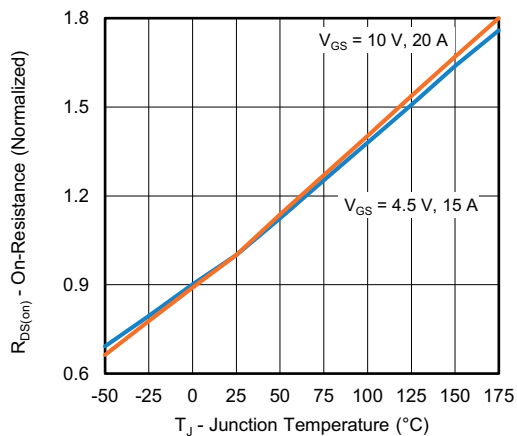
Capacitance



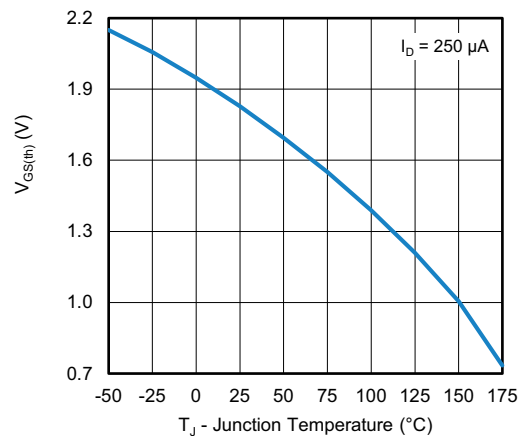
Gate Charge



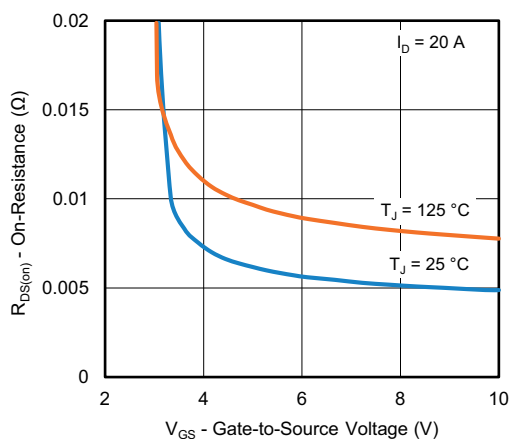
TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)



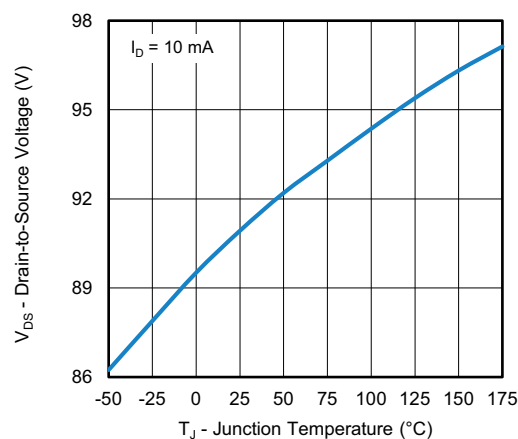
On-Resistance vs. Junction Temperature



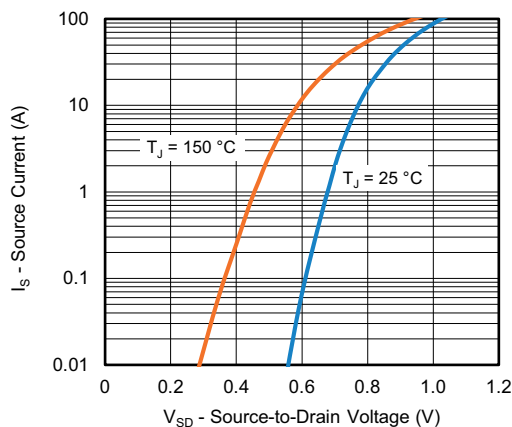
Threshold Voltage



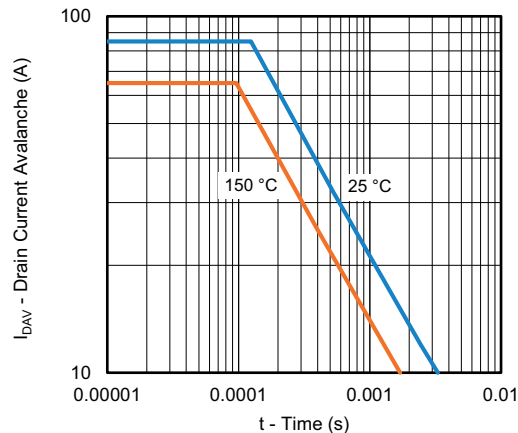
On-Resistance vs. Gate-to-Source Voltage



Drain Source Breakdown vs. Junction Temperature



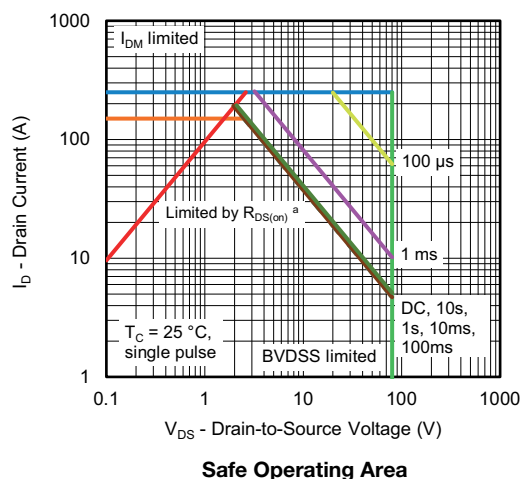
Source Drain Diode Forward Voltage



Avalanche Current vs. Time

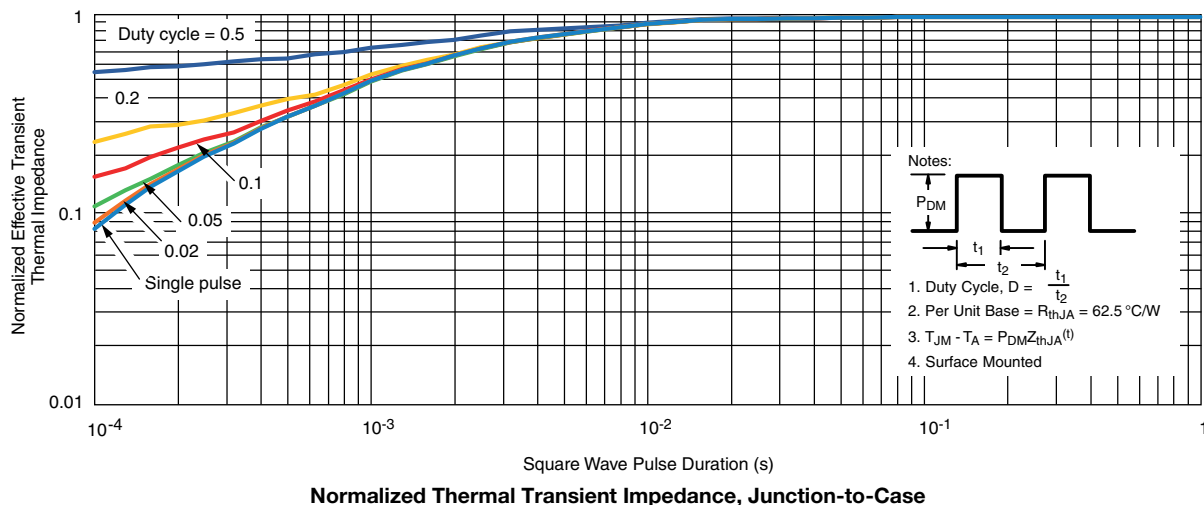


THERMAL RATINGS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)



Note

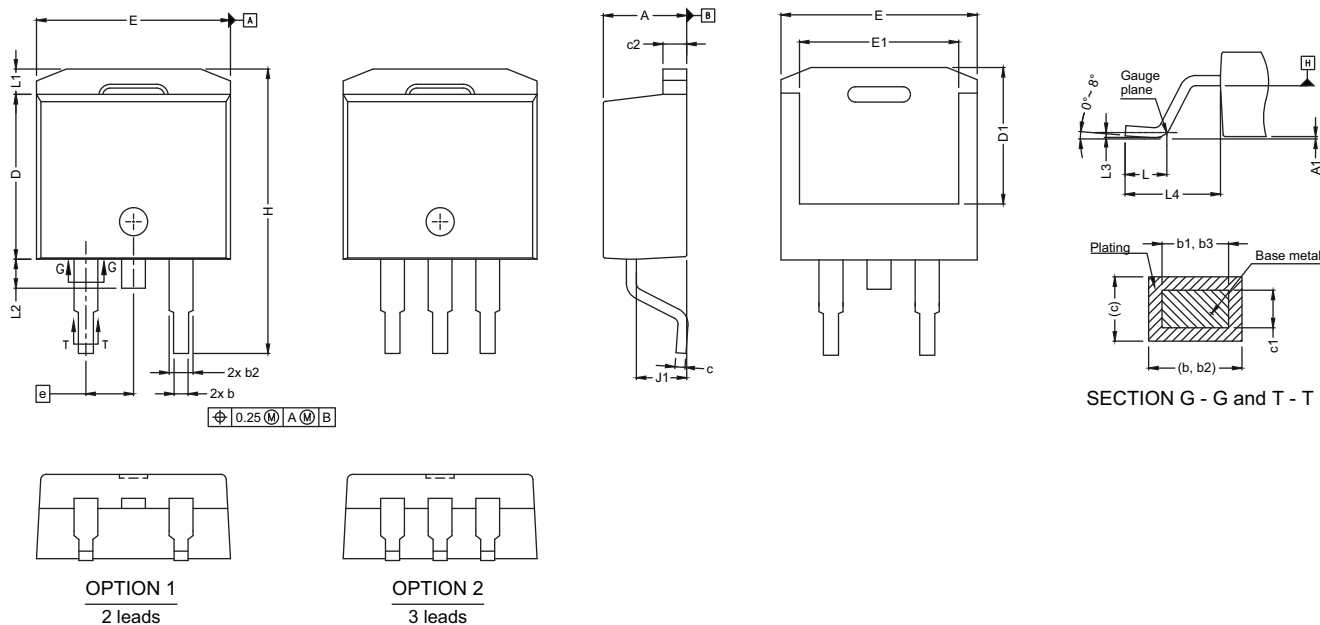
a. $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified



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VERSION 2: FACILITY CODE = N



DIM.	MIN.	MAX.
A	4.36	4.56
A1	0	0.25
b	0.70	0.90
b1	0.51	0.89
b2	1.20	1.46
b3	1.17	1.37
c	0.38	0.694
c1	0.38	0.534
c2	1.19	1.34
D	8.60	9.00
D1	6.9	7.5
E	10.15	10.55
E1	8.1	8.7
e	2.54 BSC	
H	15.0	15.6
L	1.9	2.5
L1	-	1.65
L2	-	1.78
L3	0.25 typ.	
L4	4.78	5.28
J1	2.56	2.96
ECN: S24-1080-Rev. L, 28-Oct-2024 DWG: 5843		

RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads
Dimensions in Inches/(mm)

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